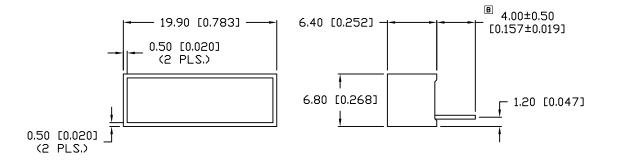
UNCONTROLLED DOCUMENT

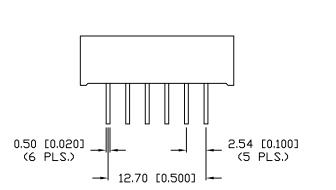
FAILT NUMBER		IVL
SSB-LX620SID		E
C.C.N. NUMBER AND REVISION COMMENTS	DA	ATE
E.C.N. #11148.	1.2	1.05

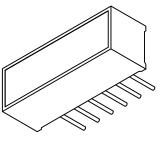
05.02.13

DADT NIIMBED



ELECTRO-OPTICAL CH	ARACTERIS	TICS TA=25°C		$I_f = 20 \text{mA}$	
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		636		nm	
FORWARD VOLTAGE		2.0	2.5	V_{f}	
REVERSE VOLTAGE	5.0			V_r	Ir=100µA
AXIAL INTENSITY		80		mcd	$I_f = 20 \text{mA}$
VIEWING ANGLE		160		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	RED DIF	FUSED			





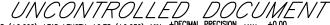
LIMITS OF SAFE OPERATION AT 25°C PER CHIP

E.C.N. #11859.

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	- 1.2	mW/°C
OPERATING, STORAGE TEMP.	- 40 TO +85	•C
SOLDERING TEMP.	+ 260	•C
2.0mm FROM BODY		3 SEC. MAX

* t<10µS

REV. Α



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.XX=±0.5 (±0.020), X.XXX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION

REV. PART NUMBER В SSB-LX620SID

6mm x 20mm, 3 CHIP LIGHT BAR, 636nm SUPER HIGH INTENSITY RED CHIPS, RED DIFFUSED, LEAD FREE.

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OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



СТ

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6.20.01 PAGE: 1 OF 1 SCALE: